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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	5MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, POR, PWM, WDT
Number of I/O	16
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f0423hh005sg

Warning: DO NOT USE THIS PRODUCT IN LIFE SUPPORT SYSTEMS.

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As used herein

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Port A–C Pull-up Enable Subregisters

The Port A–C Pull-up Enable Subregister (Table 27) is accessed through the Port A–C Control Register by writing `06H` to the Port A–C Address Register. Setting the bits in the Port A–C Pull-up Enable subregisters enables a weak internal resistive pull-up on the specified Port pins.

Table 27. Port A–C Pull-Up Enable Subregisters (PPUEx)

Bit	7	6	5	4	3	2	1	0
Field	PPUE7	PPUE6	PPUE5	PPUE4	PPUE3	PPUE2	PPUE1	PPUE0
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	If 06H in Port A–C Address Register, accessible through the Port A–C Control Register							

Bit	Description
[7:0] PPUEx	**Port Pull-up Enabled** 0 = The weak pull-up on the Port pin is disabled. 1 = The weak pull-up on the Port pin is enabled.

Note: x indicates the specific GPIO port pin number (7–0).

4. Clear the Timer PWM High and Low Byte registers to `0000H`. Clearing these registers allows the software to determine if interrupts were generated by either a capture or a reload event. If the PWM High and Low Byte registers still contain `0000H` after the interrupt, the interrupt was generated by a reload.
5. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting TICONFIG field of the TxCTL1 Register.
6. Configure the associated GPIO port pin for the Timer Input alternate function.
7. Write to the Timer Control Register to enable the timer and initiate counting.

In CAPTURE Mode, the elapsed time from timer start to capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

COMPARE Mode

In COMPARE Mode, the timer counts up to the 16-bit maximum compare value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the compare value, the timer generates an interrupt and counting continues (the timer value is not reset to `0001H`). Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) upon compare.

If the Timer reaches `FFFFH`, the timer rolls over to `0000H` and continue counting. Observe the following steps to configure a timer for COMPARE Mode and to initiate the count:

1. Write to the Timer Control Register to:
   – Disable the timer
   – Configure the timer for COMPARE Mode
   – Set the prescale value
   – Set the initial logic level (High or Low) for the Timer Output alternate function, if appropriate
2. Write to the Timer High and Low Byte registers to set the starting count value.
3. Write to the Timer Reload High and Low Byte registers to set the compare value.
4. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers.

5. Configure the associated GPIO port pin for the Timer Input alternate function.
6. Write to the Timer Control Register to enable the timer.
7. Assert the Timer Input signal to initiate the counting.

CAPTURE/COMPARE Mode

In CAPTURE/COMPARE Mode, the timer begins counting on the first external Timer Input transition. The acceptable transition (rising edge or falling edge) is set by the TPOL bit in the Timer Control Register. The timer input is the system clock.

Every subsequent acceptable transition (after the first) of the Timer Input signal captures the current count value. The capture value is written to the Timer PWM High and Low Byte registers. When the capture event occurs, an interrupt is generated, the count value in the Timer High and Low Byte registers is reset to `0001H`, and counting resumes. The `INPCAP` bit in TxCTL1 Register is set to indicate the timer interrupt is caused by an input capture event.

If no capture event occurs, the timer counts up to the 16-bit compare value stored in the Timer Reload High and Low Byte registers. Upon reaching the compare value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. The `INPCAP` bit in TxCTL1 Register is cleared to indicate the timer interrupt is not because of an input capture event.

Observe the following steps to configure a timer for CAPTURE/COMPARE Mode and initiating the count:

1. Write to the Timer Control Register to:
   - Disable the timer
   - Configure the timer for CAPTURE/COMPARE Mode
   - Set the prescale value
   - Set the capture edge (rising or falling) for the Timer Input
2. Write to the Timer High and Low Byte registers to set the starting count value (typically `0001H`).
3. Write to the Timer Reload High and Low Byte registers to set the compare value.
4. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers.By default, the timer interrupt are generated for both input capture and reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting TICONFIG field of the TxCTL1 Register.
5. Configure the associated GPIO port pin for the Timer Input alternate function.
6. Write to the Timer Control Register to enable the timer.

Watchdog Timer

The Watchdog Timer (WDT) protects against corrupt or unreliable software, power faults, and other system-level problems which can place Z8 Encore! XP F0823 Series devices into unsuitable operating states. The features of Watchdog Timer include:

- On-chip RC oscillator
- A selectable time-out response: reset or interrupt
- 24-bit programmable time-out value

Operation

The WDT is a retriggerable one-shot timer that resets or interrupts F0823 Series devices when the WDT reaches its terminal count. The Watchdog Timer uses a dedicated on-chip RC oscillator as its clock source. The Watchdog Timer operates in only two modes: ON and OFF. Once enabled, it always counts and must be refreshed to prevent a time-out. Perform an enable by executing the `WDT` instruction or by setting the WDT_AO Flash Option Bit. The `WDT_AO` bit forces the Watchdog Timer to operate immediately upon reset, even if a `WDT` instruction has not been executed.

The Watchdog Timer is a 24-bit reloadable down counter that uses three 8-bit registers in the eZ8 CPU register space to set the reload value. The nominal WDT time-out period is described by the following equation:

$$\text{WDT Time-out Period (ms)} = \frac{\text{WDT Reload Value}}{10}$$

where the WDT reload value is the decimal value of the 24-bit value given by {WDTU[7:0], WDTH[7:0], WDTL[7:0]} and the typical Watchdog Timer RC oscillator frequency is 10kHz. The Watchdog Timer cannot be refreshed after it reaches `000002H`. The WDT Reload Value must not be set to values below `000004H`. Table 59 provides information about approximate time-out delays for the minimum and maximum WDT reload values.

Table 59. Watchdog Timer Approximate Time-Out Delays

WDT Reload Value (Hex)	WDT Reload Value (Decimal)	Approximate Time-Out Delay (with 10kHz typical WDT oscillator frequency)	
		Typical	Description
000004	4	400 µs	Minimum time-out delay
FFFFFF	16,777,215	28 minutes	Maximum time-out delay

  – Set or clear CTSE to enable or disable control from the remote receiver using the $\overline{\text{CTS}}$ pin.

8. Execute an EI instruction to enable interrupts.

The UART is now configured for interrupt-driven data transmission. Because the UART Transmit Data Register is empty, an interrupt is generated immediately. When the UART Transmit interrupt is detected, the associated interrupt service routine (ISR) performs the following:

1. Write the UART Control 1 Register to select the multiprocessor bit for the byte to be transmitted:

   Set the Multiprocessor Bit Transmitter (MPBT) if sending an address byte, clear it if sending a data byte.

2. Write the data byte to the UART Transmit Data Register. The transmitter automatically transfers the data to the Transmit Shift register and transmits the data.
3. Clear the UART Transmit interrupt bit in the applicable Interrupt Request register.
4. Execute the IRET instruction to return from the interrupt-service routine and wait for the Transmit Data Register to again become empty.

Receiving Data Using the Polled Method

Observe the following steps to configure the UART for polled data reception:

1. Write to the UART Baud Rate High and Low Byte registers to set an acceptable baud rate for the incoming data stream.
2. Enable the UART pin functions by configuring the associated GPIO port pins for alternate function operation.
3. Write to the UART Control 1 Register to enable MULTIPROCESSOR Mode functions, if appropriate.
4. Write to the UART Control 0 Register to:
   – Set the receive enable bit (REN) to enable the UART for data reception
   – Enable parity, if appropriate and if Multiprocessor mode is not enabled, and select either even or odd parity
5. Check the RDA bit in the UART Status 0 Register to determine if the Receive Data Register contains a valid data byte (indicated by a 1). If RDA is set to 1 to indicate available data, continue to Step 6. If the Receive Data Register is empty (indicated by a 0), continue to monitor the RDA bit awaiting reception of the valid data.
6. Read data from the UART Receive Data Register. If operating in MULTIPROCESSOR (9-bit) Mode, further actions may be required depending on the MULTIPROCESSOR Mode bits MPMD[1:0].

Analog-to-Digital Converter

The Analog-to-Digital Converter (ADC) converts an analog input signal to its digital representation. The features of this sigma-delta ADC include:

- 10-bit resolution
- Eight single-ended analog input sources are multiplexed with general-purpose I/O ports
- Interrupt upon conversion complete
- Bandgap generated internal voltage reference generator with two selectable levels
- Factory offset and gain calibration

Architecture

Figure 19 displays the major functional blocks of the ADC. An analog multiplexer network selects the ADC input from the available analog pins, ANA0 through ANA7.

Table 81. Flash Control Register (FCTL)

Bit	7	6	5	4	3	2	1	0
Field	FCMD							
RESET	0	0	0	0	0	0	0	0
R/W	W	W	W	W	W	W	W	W
Address	FF8H							

Bit	Description
[7:0] FCMD	**Flash Command** 73H = First unlock command. 8CH = Second unlock command. 95H = Page Erase command (must be third command in sequence to initiate Page Erase). 63H = Mass Erase command (must be third command in sequence to initiate Mass Erase). 5EH = Enable Flash Sector Protect Register Access.

Table 105. Oscillator Control Register (OSCCTL)

Bit	7	6	5	4	3	2	1	0
Field	INTEN	Reserved	WDTEN	POFEN	WDFEN	SCKSEL		
RESET	1	0	1	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Address	F86H							

Bit	Description
[7] INTEN	**Internal Precision Oscillator Enable** 1 = Internal precision oscillator is enabled. 0 = Internal precision oscillator is disabled.
[6]	**Reserved** This bit is reserved and must be programmed to 0 during writes and to 0 when read.
[5] WDTEN	**Watchdog Timer Oscillator Enable** 1 = Watchdog Timer oscillator is enabled. 0 = Watchdog Timer oscillator is disabled.
[4] POFEN	**Primary Oscillator Failure Detection Enable** 1 = Failure detection and recovery of primary oscillator is enabled. 0 = Failure detection and recovery of primary oscillator is disabled.
[3] WDFEN	**Watchdog Timer Oscillator Failure Detection Enable** 1 = Failure detection of Watchdog Timer oscillator is enabled. 0 = Failure detection of Watchdog Timer oscillator is disabled.
[2:0] SCKSEL	**System Clock Oscillator Select** 000 = Internal precision oscillator functions as system clock at 5.53 MHz. 001 = Internal precision oscillator functions as system clock at 32 kHz. 010 = Reserved. 011 = Watchdog Timer oscillator functions as system clock. 100 = External clock signal on PB3 functions as system clock. 101 = Reserved. 110 = Reserved. 111 = Reserved.

Table 110. Arithmetic Instructions (Continued)

Mnemonic	Operands	Instruction
MULT	dst	Multiply
SBC	dst, src	Subtract with Carry
SBCX	dst, src	Subtract with Carry using Extended Addressing
SUB	dst, src	Subtract
SUBX	dst, src	Subtract using Extended Addressing

Table 111. Bit Manipulation Instructions

Mnemonic	Operands	Instruction
BCLR	bit, dst	Bit Clear
BIT	p, bit, dst	Bit Set or Clear
BSET	bit, dst	Bit Set
BSWAP	dst	Bit Swap
CCF	—	Complement Carry Flag
RCF	—	Reset Carry Flag
SCF	—	Set Carry Flag
TCM	dst, src	Test Complement Under Mask
TCMX	dst, src	Test Complement Under Mask using Extended Addressing
TM	dst, src	Test Under Mask
TMX	dst, src	Test Under Mask using Extended Addressing

Table 112. Block Transfer Instructions

Mnemonic	Operands	Instruction
LDCI	dst, src	Load Constant to/from Program Memory and Auto-Increment Addresses
LDEI	dst, src	Load External Data to/from Data Memory and Auto-Increment Addresses

Lower Nibble (Hex) / Upper Nibble (Hex)

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
0																
1																
2																
3																
4																
5																
6																
7	3 ,															
8																
9																
A			3.3 **CPC** r1,r2	3.4 **CPC** r1,Ir2	4.3 **CPC** R2,R1	4.4 **CPC** IR2,R1	4.3 **CPC** R1,IM	4.4 **CPC** IR1,IM	5.3 **CPCX** ER2,ER1	5.3 **CPCX** IM,ER1						
B																
C	3.2 **SRL** R1	3.3 **SRL** IR1														
D																
E									5, 4 **LDWX** ER2,ER1							
F																

Figure 28. Second Opcode Map after 1FH

DC Characteristics

Table 121 lists the DC characteristics of the Z8 Encore! XP F0823 Series products. All voltages are referenced to V_{SS}, the primary system ground.

Table 121. DC Characteristics

		T_A = –40°C to +105°C (unless otherwise specified)				
Symbol	**Parameter**	**Minimum**	**Typical**	**Maximum**	**Units**	**Conditions**
V_{DD}	Supply Voltage	2.7	–	3.6	V	
V_{IL1}	Low Level Input Voltage	–0.3	–	0.3*V_{DD}	V	
V_{IH1}	High Level Input Voltage	0.7*V_{DD}	–	5.5	V	For all input pins without analog or oscillator function. For all signal pins on the 8-pin devices. Programmable pull-ups must also be disabled.
V_{IH2}	High Level Input Voltage	0.7*V_{DD}	–	V_{DD}+0.3	V	For those pins with analog or oscillator function (20-/28-pin devices only), or when programmable pull-ups are enabled.
V_{OL1}	Low Level Output Voltage	–	–	0.4	V	I_{OL} = 2mA; V_{DD} = 3.0V High Output Drive disabled.
V_{OH1}	High Level Output Voltage	2.4	–	–	V	I_{OH} = –2mA; V_{DD} = 3.0V High Output Drive disabled.
V_{OL2}	Low Level Output Voltage	–	–	0.6	V	I_{OL} = 20mA; V_{DD} = 3.3 V High Output Drive enabled.
V_{OH2}	High Level Output Voltage	2.4	–	–	V	I_{OH} = –20mA; V_{DD} = 3.3 V High Output Drive enabled.
I_{IH}	Input Leakage Current	–	±0.002	±5	µA	V_{IN} = V_{DD} V_{DD} = 3.3 V
I_{IL}	Input Leakage Current	–	±0.007	±5	µA	V_{IN} = V_{SS} V_{DD} = 3.3 V
I_{TL}	Tristate Leakage Current	–	–	±5	µA	

Notes:
1. This condition excludes all pins that have on-chip pull-ups, when driven Low.
2. These values are provided for design guidance only and are not tested in production.

available to the eZ8 CPU on the second rising clock edge following the change of the port value.

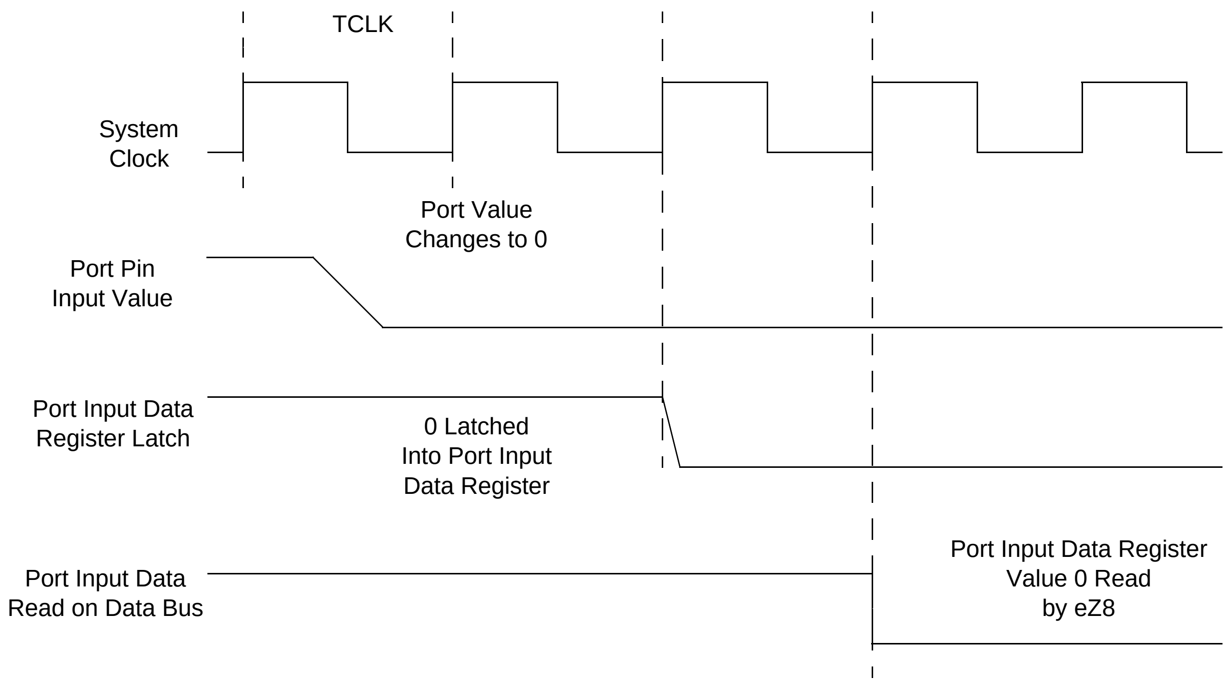

Figure 29. Port Input Sample Timing

Table 130. GPIO Port Input Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
T_{S_PORT}	Port Input Transition to X_{IN} Rise Setup Time (Not pictured)	5	–
T_{H_PORT}	X_{IN} Rise to Port Input Transition Hold Time (Not pictured)	0	–
T_{SMR}	GPIO Port Pin Pulse Width to ensure Stop Mode Recovery (for GPIO Port Pins enabled as SMR sources)	1 µs	

On-Chip Debugger Timing

Figure 31 and Table 132 provide timing information for the DBG pin. The DBG pin timing specifications assume a 4 ns maximum rise and fall time.

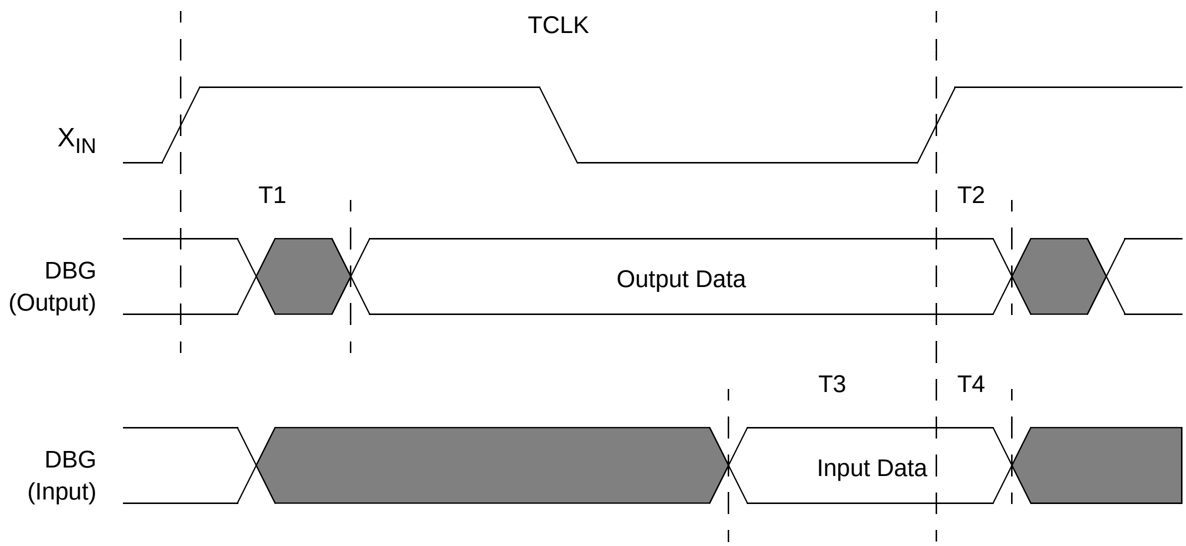

Figure 31. On-Chip Debugger Timing

Table 132. On-Chip Debugger Timing

		Delay (ns)	
Parameter	**Abbreviation**	**Minimum**	**Maximum**
DBG			
T_1	X_{IN} Rise to DBG Valid Delay	–	15
T_2	X_{IN} Rise to DBG Output Hold Time	2	–
T_3	DBG to X_{IN} Rise Input Setup Time	5	–
T_4	DBG to X_{IN} Rise Input Hold Time	5	–

Figure 33 and Table 134 provide timing information for UART pins for the case where CTS is not used for flow control. DE asserts after the transmit data register has been written. DE remains asserted for multiple characters as long as the transmit data register is written with the next character before the current character has completed.

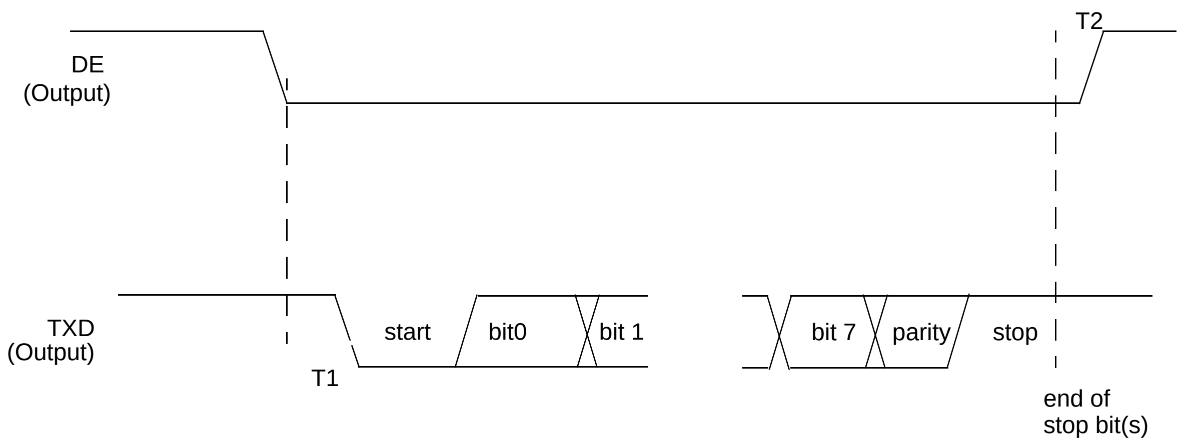

Figure 33. UART Timing Without CTS

Table 134. UART Timing Without CTS

Parameter	Abbreviation	Delay (ns) Minimum	Delay (ns) Maximum
UART			
T_1	DE assertion to TXD falling edge (start bit) delay	1 * X_{IN} period	1 bit time
T_2	End of Stop Bit(s) to DE deassertion delay (Tx data register is empty)	± 5	

Part Number Suffix Designations

Zilog part numbers consist of a number of components, as indicated in the following example.

Example. Part number Z8F0423SH005SG is an 8-bit 20MHz Flash MCU with 4KB of Program Memory and equipped with 6–22 I/O lines and 4–8 ADC channels in a 20-pin SOIC package, operating within a 0ºC to +70ºC temperature range and built using lead-free solder.

Z8 F 04 23 S H 005 S G

Environmental Flow
G = Green Plastic Packaging Compound

Temperature Range
S = Standard, 0°C to 70°C
E = Extended, –40°C to +105°C

Speed
020 = 20MHz

Pin Count
B = 8
H = 20
J = 28

Package
H = SSOP
P = PDIP
S = SOIC

Device Type
23 = 6–22 I/O lines, 4–8 ADC channels
13 = 6–24 I/O lines, no ADC channels

Memory Size
08 = 8 KB Flash, 1 KB RAM
04 = 4 KB Flash, 1 KB RAM
02 = 2 KB Flash, 512 B RAM
01 = 1 KB Flash, 256 B RAM

Memory Type
F = Flash

Device Family
Z8 = Zilog's 8-Bit Microcontroller

G

H

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M

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R